

Silicon Carbide Schottky Diode

IDW40G120C5B

5th Generation CoolSiC[™] 1200 V SiC Schottky Diode

Final Datasheet

Rev. 2.2 2021-03-01

Industrial Power Control

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5th Generation CoolSiC[™] 1200 V SiC Schottky Diode

CoolSiC[™] SiC Schottky Diode

Features:

- Revolutionary semiconductor material Silicon Carbide
- No reverse recovery current / No forward recovery
- Temperature independent switching behavior
- Low forward voltage even at high operating temperature
- Tight forward voltage distribution
- Excellent thermal performance
- Extended surge current capability
- Specified dv/dt ruggedness
- Qualified according to JEDEC¹⁾ for target applications
- Pb-free lead plating; RoHS compliant

Benefits

- System efficiency improvement over Si diodes
- Enabling higher frequency / increased power density solutions
- System size/cost savings due to reduced heatsink requirements and smaller magnetics
- Reduced EMI
- Highest efficiency across the entire load range
- Robust diode operation during surge events
- High reliability
- RelatedLinks: <u>www.infineon.com/sic</u>

Applications

- Solar inverters
- Uninterruptable power supplies
- Motor drives
- Power Factor Correction

Package pin definitions

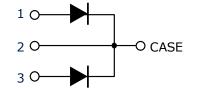
- Pin 1 anode 1
- Pin 2 and backside cathode
- Pin 3 anode 2

Key Performance and Package Parameters (leg/device)

Туре	V _{DC}	l _F	Q _C	T j,max	Marking	Package
IDW40G120C5B	1200V	20 / 40 A	101 / 202nC	175°C	D4012B5	PG-TO247-3

1) J-STD20 and JESD22

Final Data S	Sheet
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Maximum ratings

Parameter	Symbol	Value (leg/device)	Unit	
Repetitive peak reverse voltage	Vrrm	1200	V	
Continuous forward current for $R_{th(j-c,max)}$ $T_c = 148^{\circ}C, D=1$ $T_c = 135^{\circ}C, D=1$ $T_c = 25^{\circ}C, D=1$	IF	20 / 40 25 / 51 55 / 110	A	
Surge non-repetitive forward current, sine halfwave $T_{C}=25$ °C, t _p =10ms $T_{C}=150$ °C, t _p =10ms	I _{F,SM}	145 / 290 140 / 280	A	
Non-repetitive peak forward current $T_{\rm C} = 25^{\circ}$ C, $t_{\rm p}$ =10 µs	<i>I</i> _{F,max}	1575 / 3150	А	
i ² t value $T_{\rm C} = 25^{\circ}{\rm C}, t_{\rm p} = 10 \text{ ms}$ $T_{\rm C} = 150^{\circ}{\rm C}, t_{\rm p} = 10 \text{ ms}$	∫ i²dt	105 / 420 98 / 392	A²s	
Diode dv/dt ruggedness $V_R=0960 V$	d <i>v</i> /dt	150	V/ns	
Power dissipation for $R_{th(j-c,max)}$ $T_c = 25^{\circ}C$	P _{tot}	201 / 402	W	
Operating and storage temperature	Tj;Tstg	-55175	°C	
Soldering temperature, wavesoldering only allowed at leads 1.6mm (0.063 in.) from case for 10 s	T _{sold}	260	°C	
Mounting torque M3 and M4 screws	М	0.7	Nm	

Thermal Resistances

Parameter	Symbol	Conditions	Value (leg/device)			Unit
Faiamelei			min.	typ.	max.	Unit
Characteristic						
Diode thermal resistance, junction – case	R _{th(j-c)}		-	0.6/0.3	0.8/0.4	K/W
Thermal resistance, junction – ambient	Rth(j-a)	leaded	-	-	62	K/W



Electrical Characteristics

Static Characteristic, at Tj=25°C, unless otherwise specified

Parameter	Symbol	Conditions	Value (leg/device)			Unit
Faiallelei			min.	typ.	max.	Unit
DC blocking voltage	V _{DC}	$T_{\rm j} = 25^{\circ}{\rm C}$	1200	-	-	V
Diode forward voltage	VF	<i>I</i> ⊧= 20/40 A, <i>T</i> j=25°C	-	1.4	1.65	V
	VF	<i>I</i> ⊧= 20/40 A, <i>T</i> j=150°C	-	1.7	2.30	
Reverse current	<i>I</i> _R	V _R =1200 V, <i>T</i> _j =25°C		12 / 23	166 / 332	μA
Reverse current		<i>V</i> _R =1200 V, <i>T</i> _j =150°C		59 / 118	850 / 1700	

Dynamic Characteristics, at Tj=25°C, unless otherwise specified

Parameter	Symbol	Conditions	Value (leg/device)			Unit
Falanelei	Symbol		min.	typ.	max.	Onic
Total capacitive charge		$V_{\rm R} = 800 \text{ V}, T_{\rm j} = 150^{\circ} \text{C} \& 25^{\circ} \text{C}$				
	Qc	$Q_C = \int_0^{V_R} C(V) dV$	-	101 / 202	-	nC
		<i>V</i> _R =1 V, <i>f</i> =1 MHz	-	1296/2592	-	
Total Capacitance	С	<i>V</i> _R =400 V, <i>f</i> =1 MHz	-	92 / 183	-	pF
		V _R =800 V, <i>f</i> =1 MHz	-	73 / 146	-	

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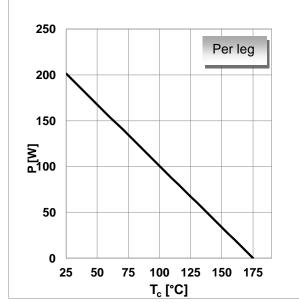


Figure 1. Power dissipation per leg as function of case temperature, P_{tot}=f(T_C), R_{th(j-c),max}

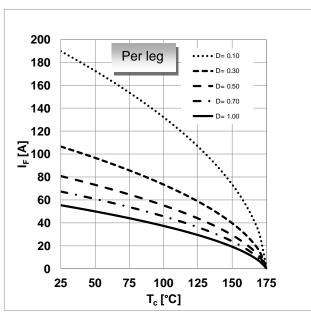


Figure 2. Diode forward current per leg as function of temperature, parameter: $T_j \le 175^{\circ}$ C, $R_{th(j-c),max}$, D=duty cycle, Vth, R_{diff} @ $T_j = 175^{\circ}$ C

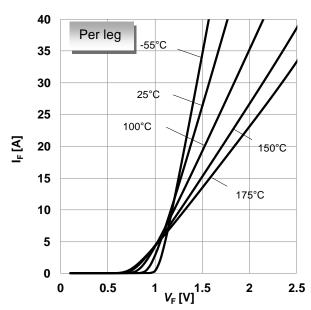


Figure 3. Typical forward characteristics per leg, $I_{F}=f(V_{F}), t_{p}=10 \ \mu s, \text{ parameter: } T_{j}$

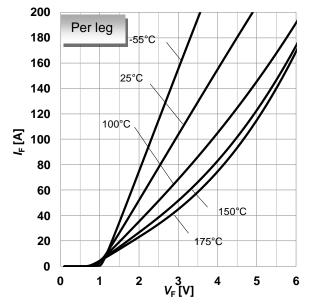


Figure 4. **Typical forward characteristics in surge current per leg**, *I*_F=f(*V*_F), *t*_p= 10 μs, parameter: *T*_j



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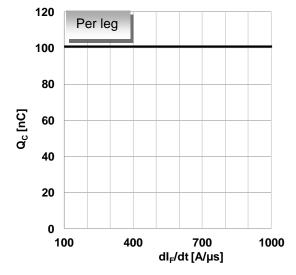
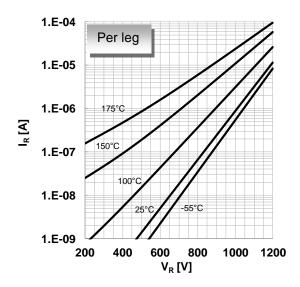
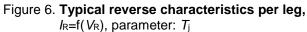


Figure 5. Typical capacitive charge per leg as function of current slope¹, $Q_C=f(dI_F/dt)$, $T_j=150^{\circ}C$ 1) guaranteed by design.





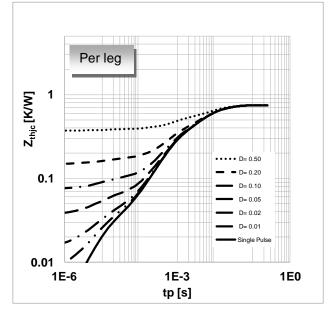


Figure 7. Max. transient thermal impedance per leg, $Z_{th,j-c}=f(t_P)$, parameter: $D=t_P/T$

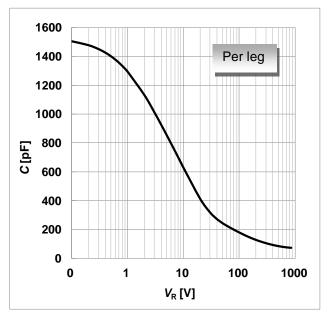


Figure 8. Typical capacitance per leg as function of reverse voltage, C=f(V_R); T_j=25°C; f=1 MHz



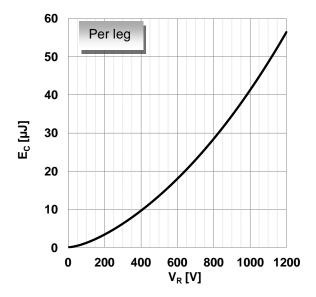
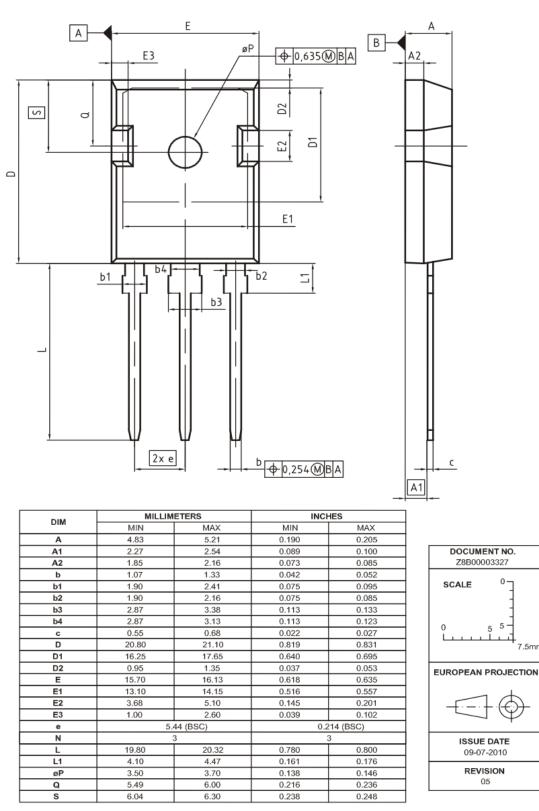


Figure 9. Typical capacitively stored energy as function of reverse voltage, per leg, $E_{C}=f(V_{R})$



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Revision History

IDW40G120C5B

Revision: 2021-03-01, Rev. 2.2

Previous Revision:						
Revision	Date Subjects (major changes since last version)					
2.0	2014-06-10	Final data sheet				
2.1	2017-07-21	Editorial Changes				
2.2	2021-03-01	Increased dv/dt ruggedness				

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